# DSC7004

### Silicon NPN epitaxial planar type

For low frequency amplification Complementary to DSA7004

#### Features

- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

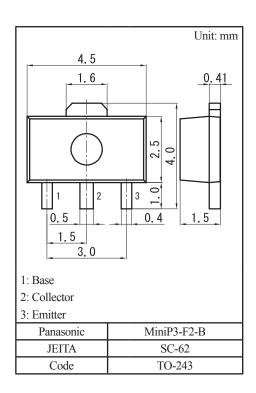
#### Marking Symbol: 5B

#### Packaging

DSC7004×0L Embossed type (Thermo-compression sealing): 1 000 pcs / reel (standard)

Absolute Maximum Ratings T <sub>a</sub> 25 C							
Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	60	V				
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	V				
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V				
Collector current	I <sub>C</sub>	2	А				
Peak collector current	I <sub>CP</sub>	3	А				
Collector power dissipation	P <sub>C</sub>	1	W				
Junction temperature	Tj	150	°C				
Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C				





Note) Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

Absolute maximum rating without heat sink for  $P_C$  is 0.5 W

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu {\rm A}, I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 10 \ \mu {\rm A}, \ I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = 2 V, I_C = 200 mA$	120		340	
	h <sub>FE2</sub>	$V_{CE} = 2 V, I_C = 1 A$	80			
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_{\rm C} = 1  \text{A}, I_{\rm B} = 50  \text{mA}$		0.15	0.3	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_{\rm C} = 1  \text{A}, I_{\rm B} = 50  \text{mA}$		0.9	1.2	V
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, I_C = 50 \text{ mA}$		120		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		22	35	pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*1: Pulse measurement

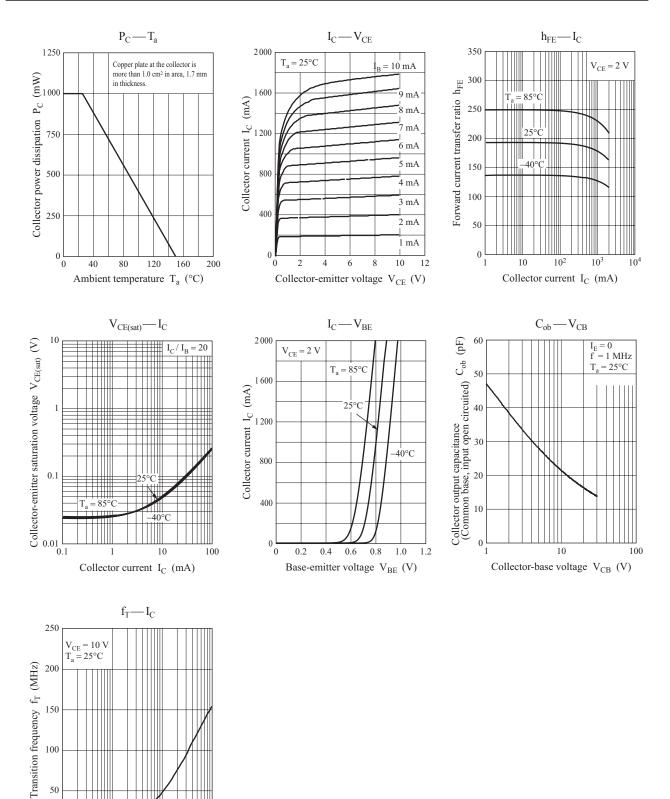
\*2: Rank classification

2. Runk elussifieution				
Code	R	S	0	
Rank	R	S	No-rank	
h <sub>FE1</sub>	120 to 240	170 to 340	120 to 340	
Marking Symbol	5BR	5BS	5B	

Product of no-rank is not classified and have no marking symbol for rank.

50

0 0.1



100

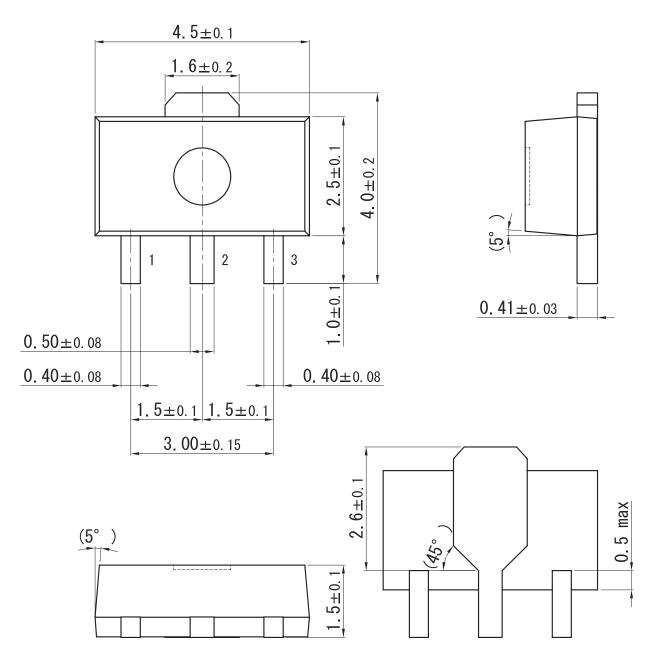
10

1

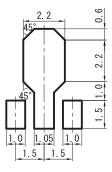
Collector current I<sub>C</sub> (mA)

MiniP3-F2-B

Unit: mm



Land Pattern (Reference) (Unit: mm)



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